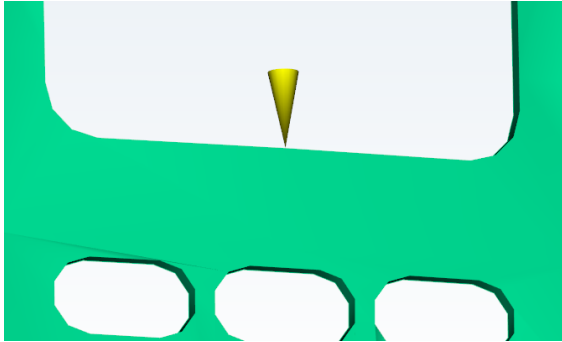


## Molding Window

Model: Phone

Task: Evaluate process conditions of thickness change

Studies
1. Phone 16
2. Phone 10



Injection location	
X:	-65
Y:	-4.4
Z:	7

Material Data:
Training Materials : Training PC Unfilled (Lexan HF1110)

Table 9 Phone	Mold Temperature °C	Melt Temperature °C	Injection Time s
1. Material recommended processing conditions			X
2. Phone 1.6 mm (from Summary panel)			
3. Phone 1.6 mm injection time range, Zone plot	X	X	
4. Phone 1.0 mm (from Summary panel)			
5. Phone 1.0 mm injection time range, Zone plot	X	X	